

# Headspace Analysis of Residual Solvents in Pharmaceuticals, Using Flow-Modulation Chromatography.

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# Application: Residual Solvents

- Pharmaceutical Formulations
- Guidelines for Testing
  - International Conference on Harmonization
  - European Pharmacopoeia
- Compound Lists Vary
  - Over 60 compounds of regulatory interest
  - Classes based on toxicities
  - Resolution of large lists on a single stationary phase can be extremely difficult

# The Three Approaches:

- Evaluate Existing Phases
- Develop a New Stationary Phase
- Stop-Flow GC Technology
  - Using Existing RT Data
  - Applying RT Data for Stop-Flow

# Existing Phases Evaluated

- Change in selectivity
- Low bleed
- Critical resolution
- FID or MS detection

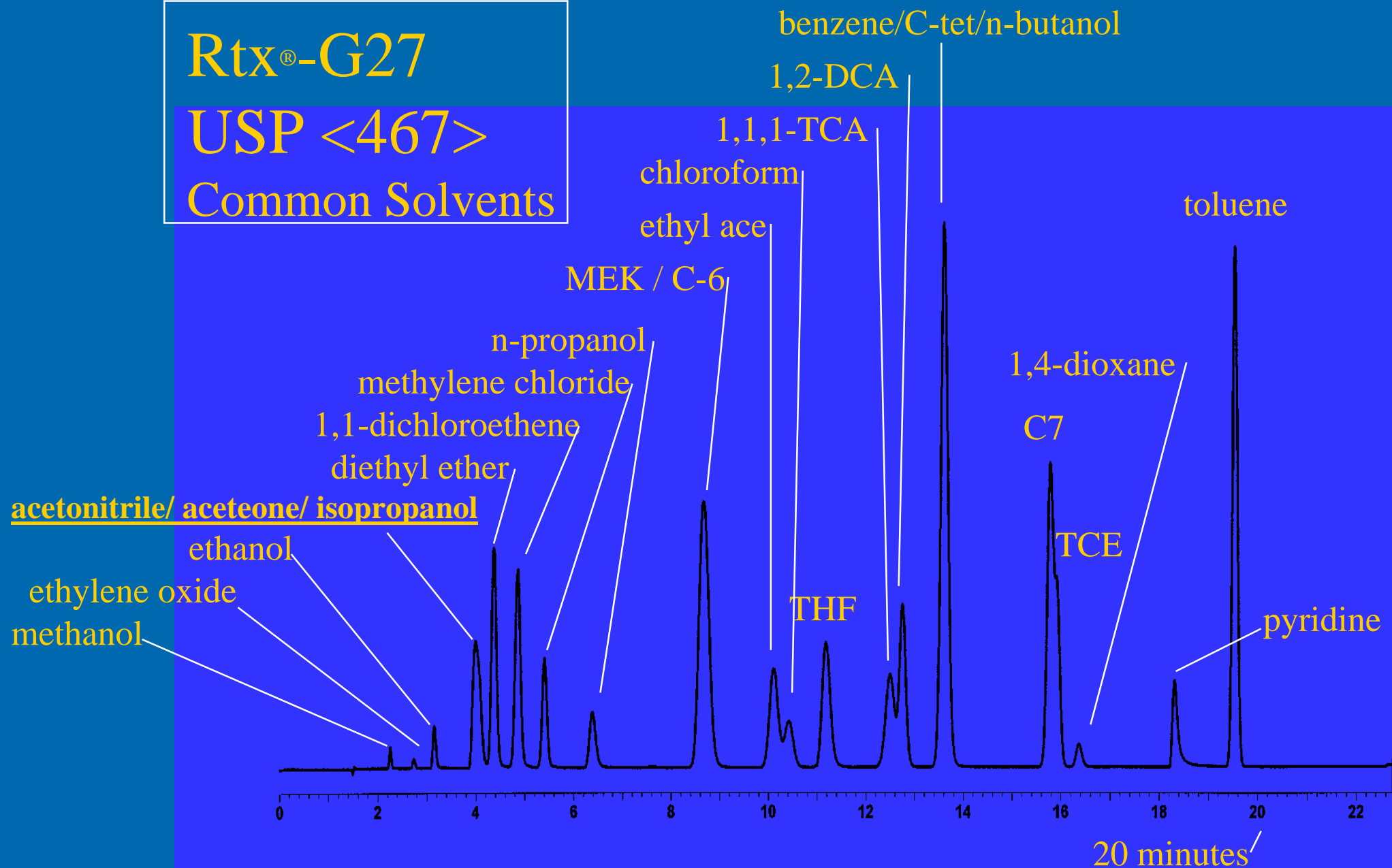


- Column Design.

Rtx<sup>®</sup>-G27

USP <467>

Common Solvents

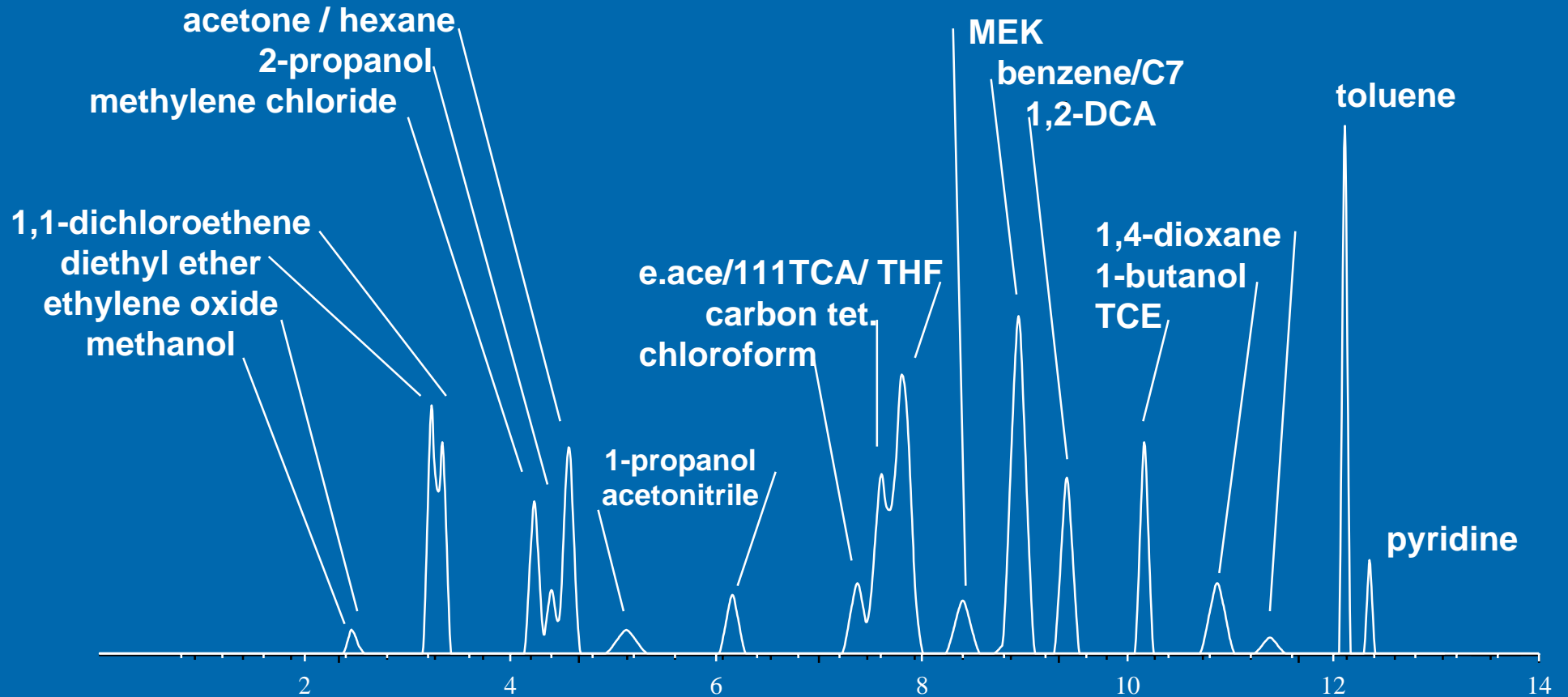


# The Rtx-G27 Unresolved

- acetonitrile (II), acetone (III), IPA (III)
- MEK (III), C6 (II)
- benzene (I), carbon tet. (I), n-butanol (III)
- C7 (III), TCE (II)

# Rtx<sup>®</sup>-VGC

## USP <467> Common Solvents



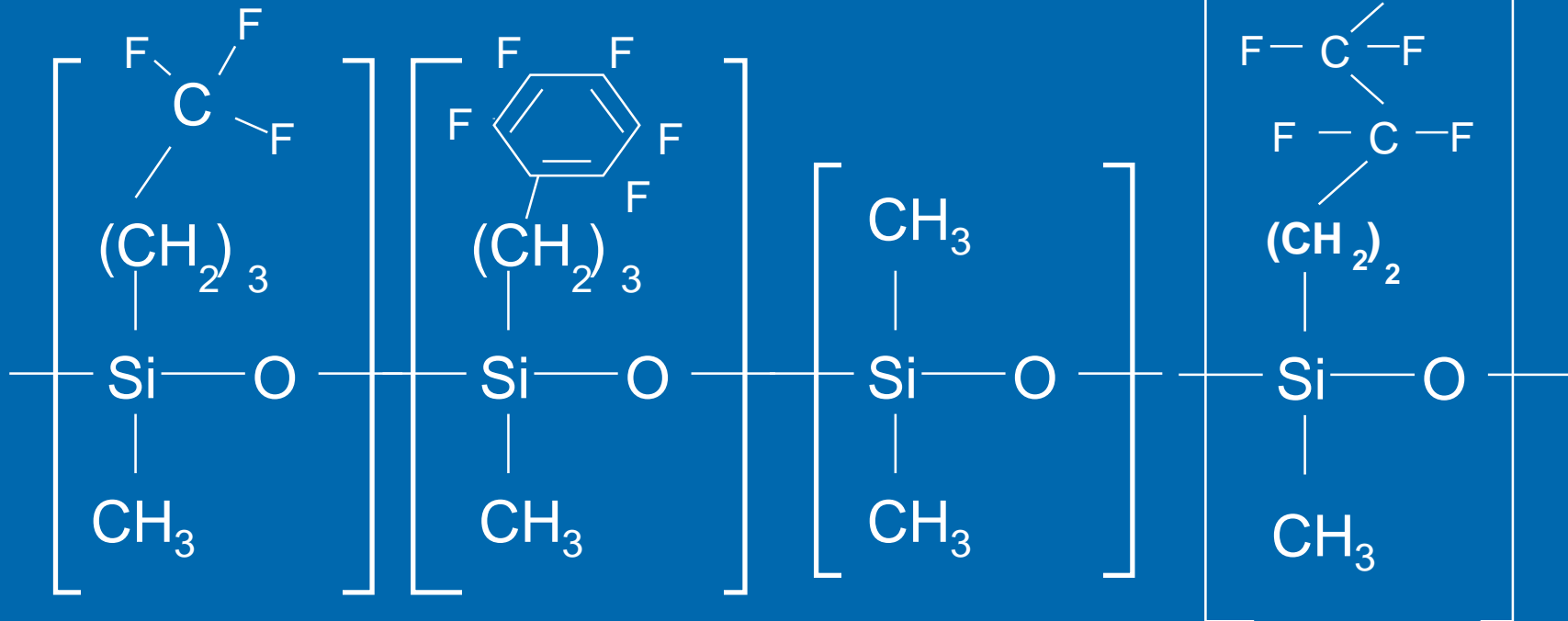
# The Rtx-VGC Unresolved

- acetone (III), C6 (II)
- E.ace (III), 111TCA (I), THF (III)
- benzene (I), C7 (III)

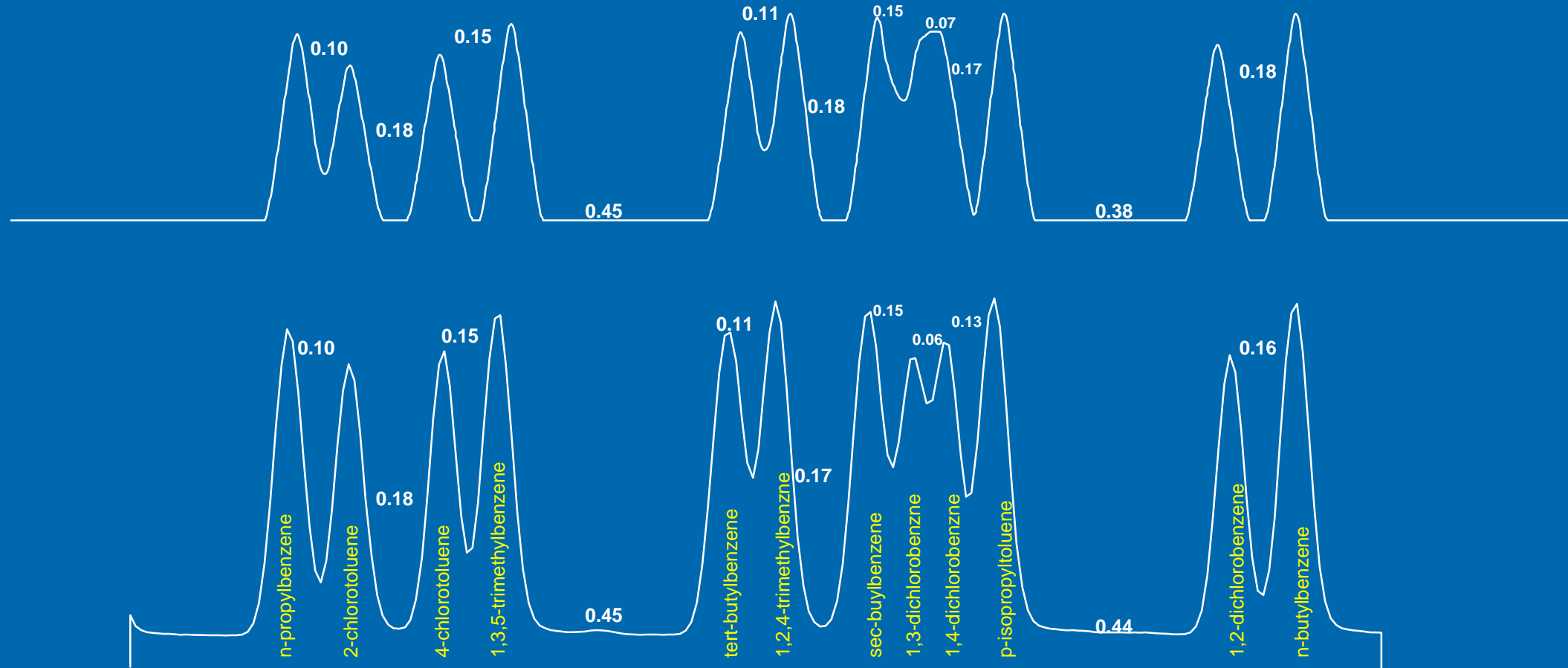


# Experimental Fluorinated Phase

## Bonded Polymer Examined for GC Applications.

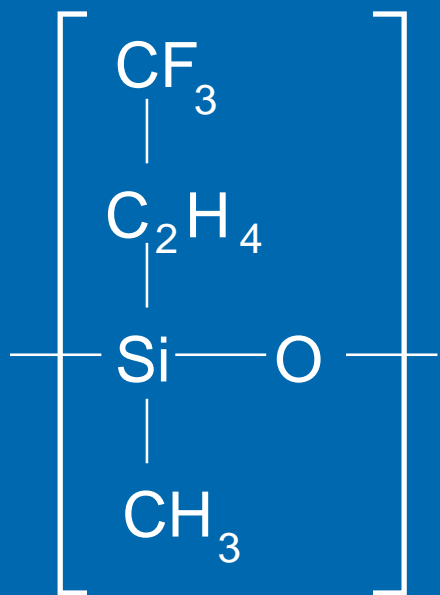


# Modeling for a New Bonded Phase

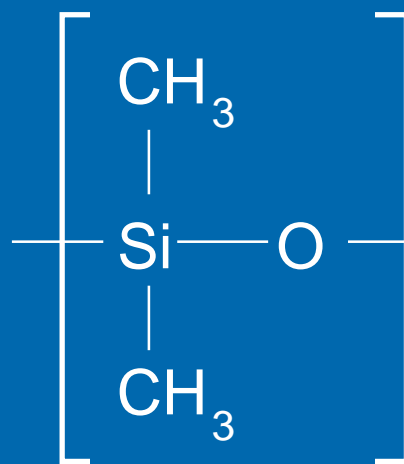


# Stationary Phases Used for Modeling

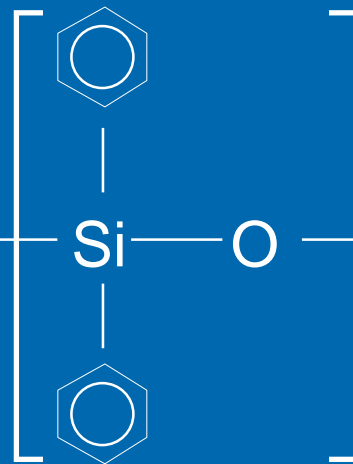
trifluoropropylmethyl  
polysiloxane



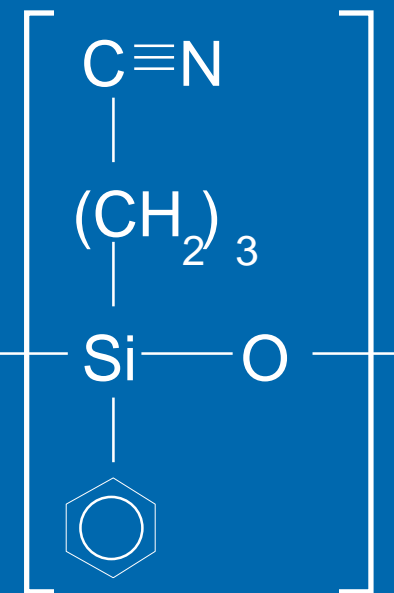
dimethyl  
polysiloxane



diphenyl  
polysiloxane



cyanopropylphenyl  
polysiloxane



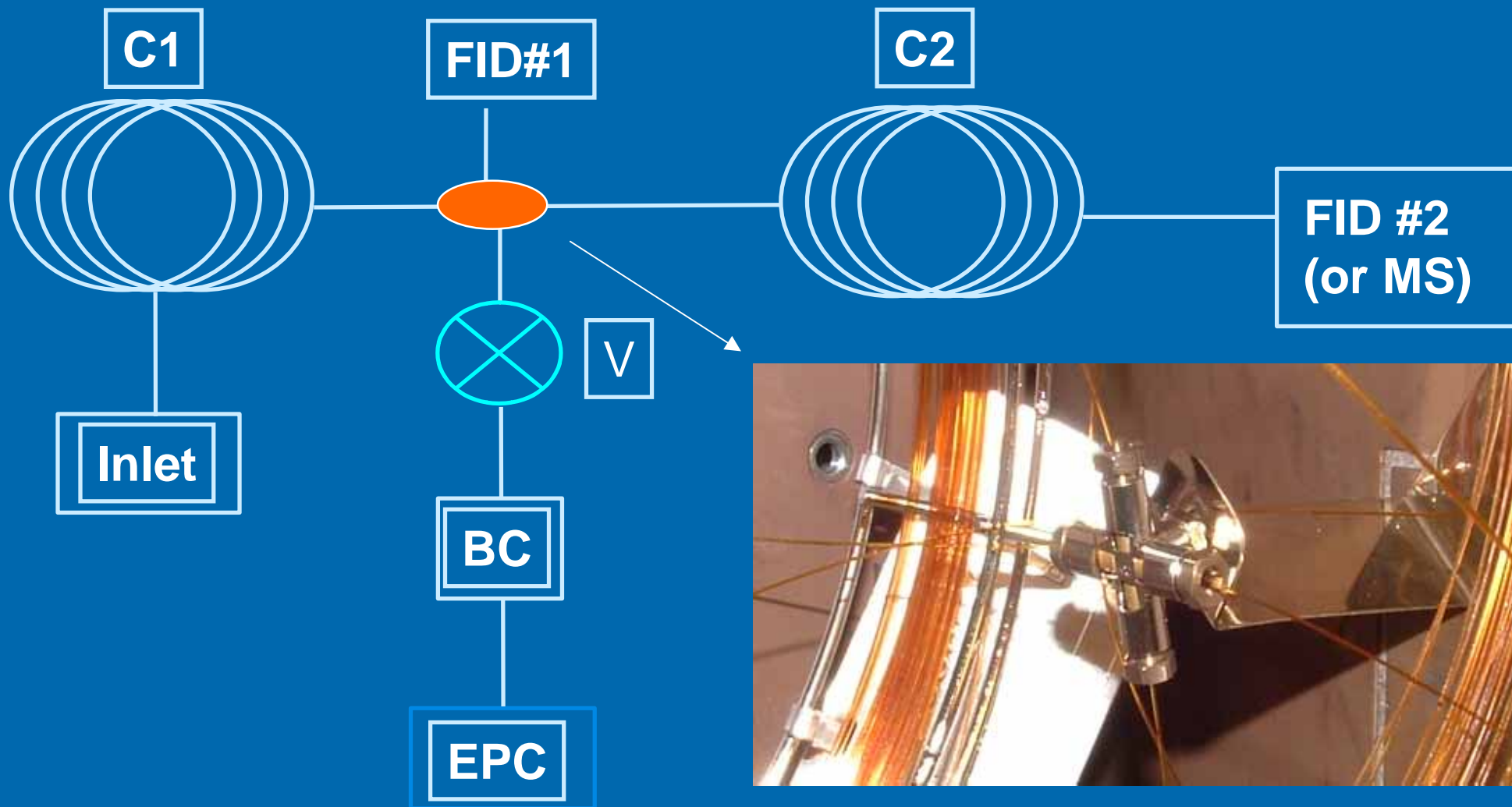
# Current Issues with the ICH Compounds.

Separation  
Concentration

# Headspace & Stop Flow



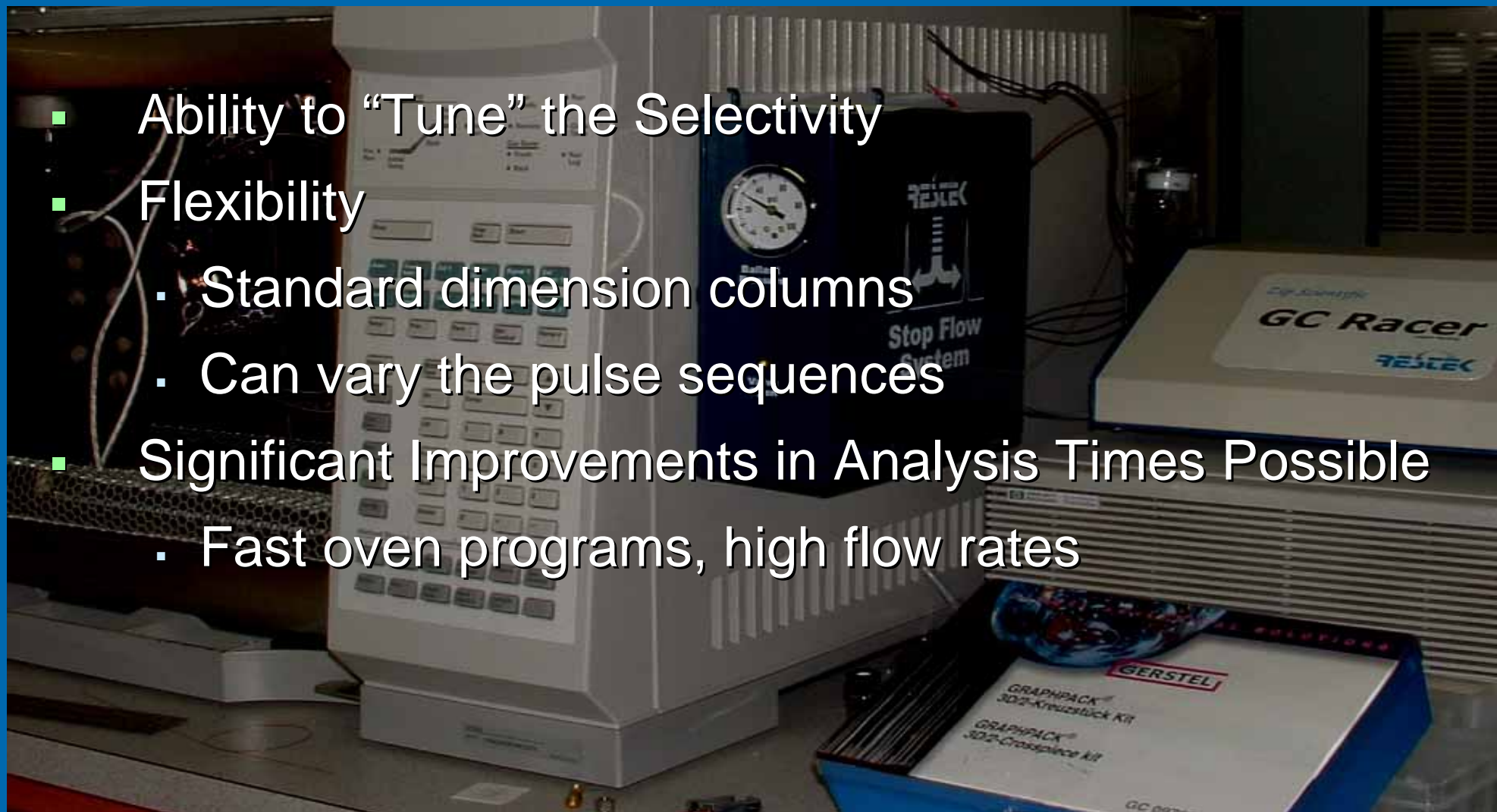
# Stop Flow GC System: Sacks, et. al.\*



\*Richard Sacks, University of Michigan

# Summary of Stop-Flow GC

- Ability to “Tune” the Selectivity
- Flexibility
  - Standard dimension columns
  - Can vary the pulse sequences
- Significant Improvements in Analysis Times Possible
  - Fast oven programs, high flow rates





# Class I & II Residual Solvents

Peak #	Compound	Peak #	Compound
1	2-methylpentane	19	1,2-dichloroethane (1,2-DCA)
2	hexane	20	2-hexanone (MBK)
3	methyl cyclopentane	21	p-xylene
4	1,1-dichloroethene (1,1-DCE)	22	m-xylene
5	methyl cyclohexane	23	nitromethane
6	<i>trans</i> -1,2-dichloroethene	24	2-methoxyethanol
7	carbon tetrachloride (CCl <sub>4</sub> )	25	pyridine
8	1,1,1-trichloroethane (1,1,1-TCA)	26	o-xylene
9	methanol	27	chlorobenzene
10	1,2-dimethoxyethane	28	2-ethoxyethanol
11	methylene chloride (CH <sub>2</sub> Cl <sub>2</sub> )	29	1,1,2-trichloroethane (1,1,2-TCA)
12	benzene	30	dimethyl formamide (DMF)
13	<i>cis</i> -1,2-dichloroethene	31	N,N-dimethylacetamide (DMA)
14	trichloroethene (TCE)	32	1,2,3,4-tetrahydronaphthalene (THN)
15	acetonitrile (MeCN)	33	ethylene glycol (EG)
16	chloroform	34	1-methyl-2-pyrrolidinone (1-MP)
17	toluene	35	formamide
18	1,4-dioxane	36	sulfolone



# Coelutions by Phase

## Class I & II

### Rtx-1

1,2-dichloroethane / methyl cyclopentane  
1,4-dioxane / trichloroethene  
p-xylene / m-xylene

### Rtx-200

hexane / methylene chloride  
1,2-dichloroethane / trichloroethene  
2-ethoxyethanol / toluene

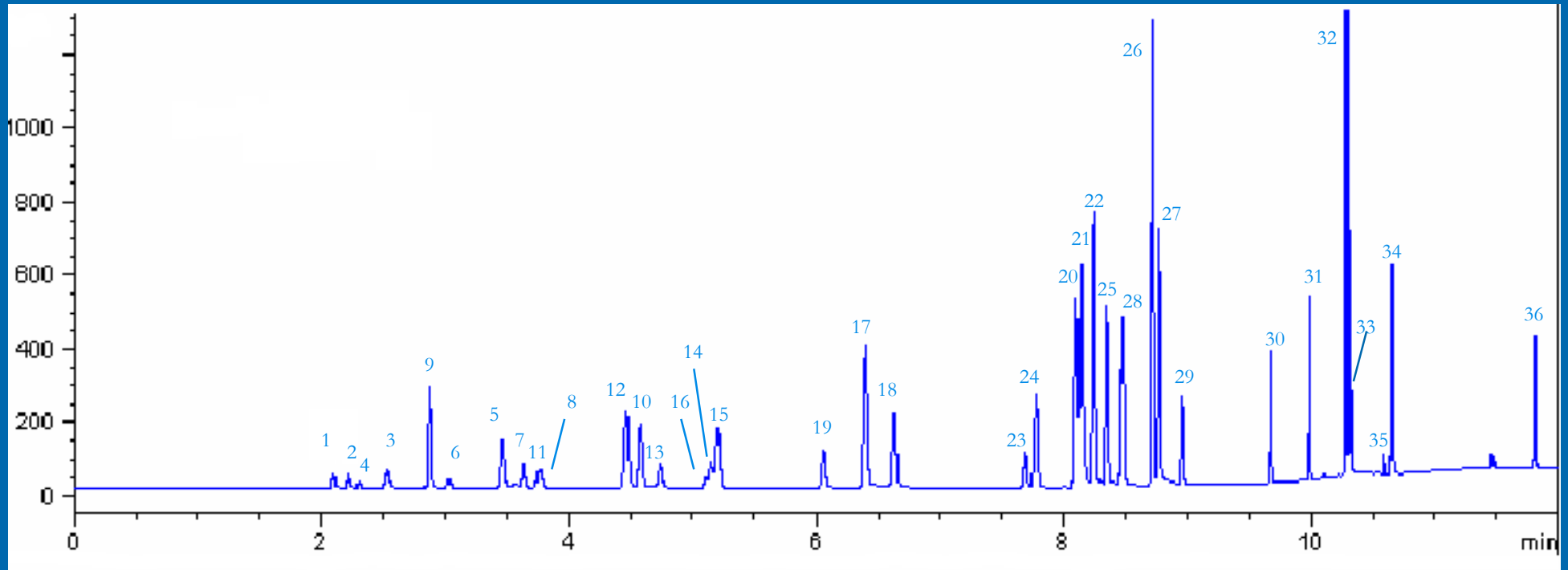
### Stabilwax

carbon tetrachloride / 1,1,1-trichloroethane  
cis-1,2-dichloroethene / trichloroethene

### Rtx-VMS

Carbon tetrachloride / 1,1,1-trichloroethane (close pair)  
Trichloroethene / methyl cyclohexane  
p-xylene / m-xylene

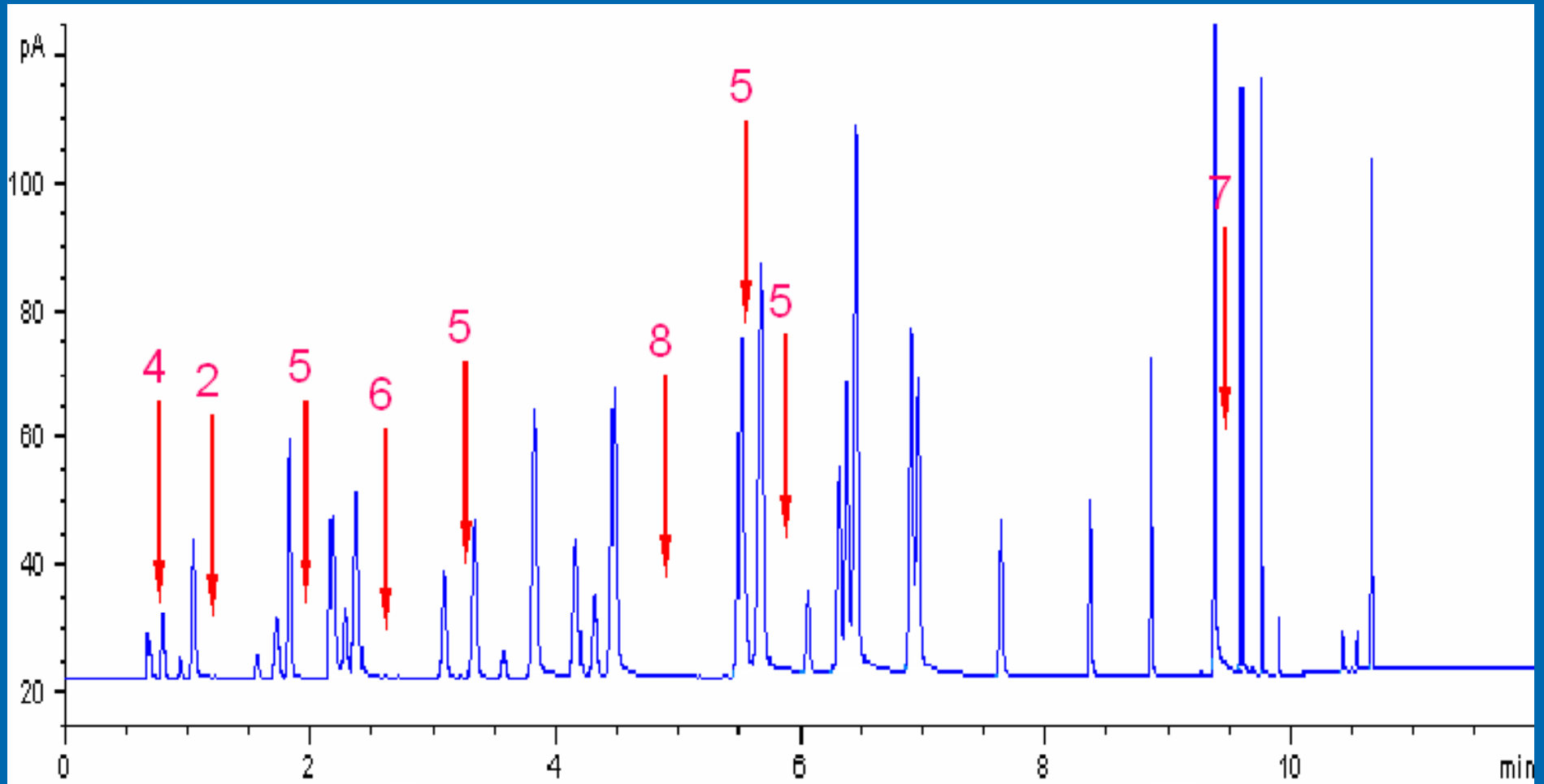
# Class I & II OVIs: Total of 9 Pulses *At the End Detector – all 36 resolved*



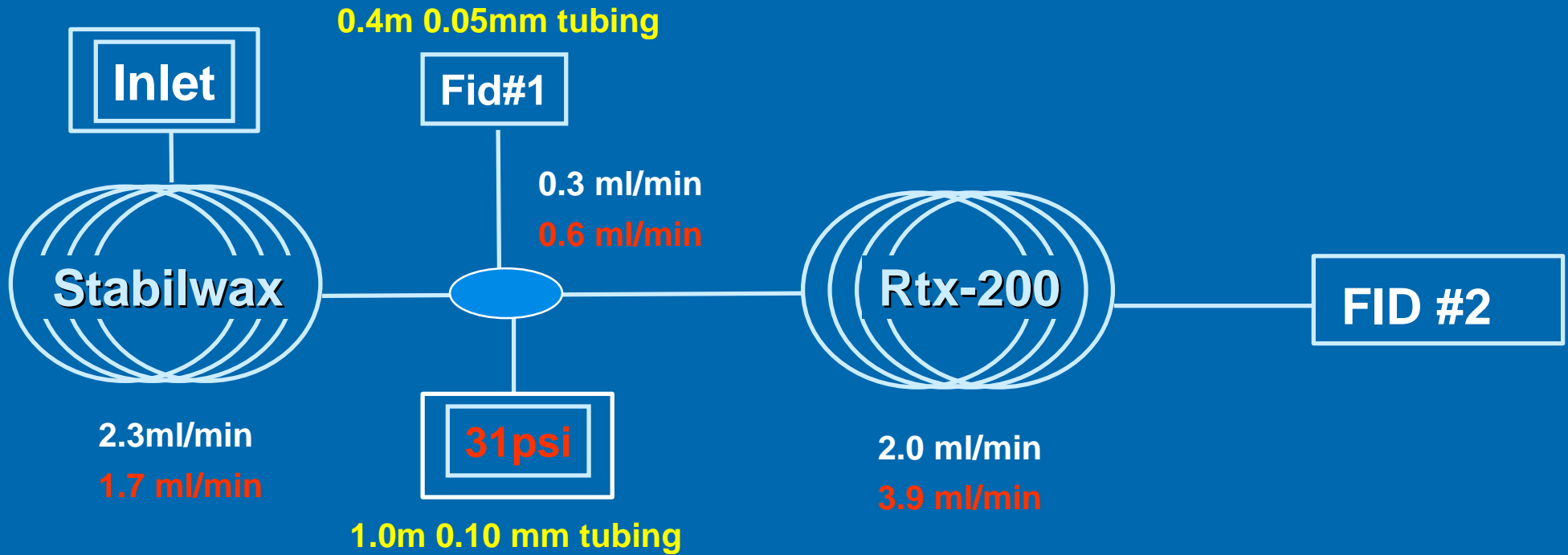
# Residual Solvents: Run Conditions

	<i>Standard Procedure</i>	<i>Fast Procedure</i>
<b>Analytical Columns</b>	<b>Stabilwax</b> 15m x 0.25mm, 0.5 $\mu$ m <b>Rtx-200</b> 30m x 0.25mm, 1 $\mu$ m	<b>Stabilwax</b> 15m x 0.25mm, 0.5 $\mu$ m <b>Rtx-200</b> 30m x 0.25mm, 1 $\mu$ m
<b>Oven Program</b>	40°C (6 min. hold) to 100°C at 4°C/min., to 220°C at 15°C/min., 5 min. hold	40°C (1 min. hold) to 65°C at 6°C/min., to 100°C at 12°C/min., to 250°C at 70°C/min., 1.8 min. hold
<b>Column Flow</b>	1.5 mL/min. constant flow	2.5 mL/min. to 9.5 min. 3.5 mL/min. at 10 min.
<b>Injector</b>	230°C	230°C
<b>Injection</b>	0.2 $\mu$ L HS, 200:1 split	0.2 $\mu$ L HS, 200:1 split
<b>Detectors</b>	Dual FIDs @ 250°C	Dual FIDs @ 250°C

# Class I & II OVIs: Total of 9 Pulses *At the Junction*

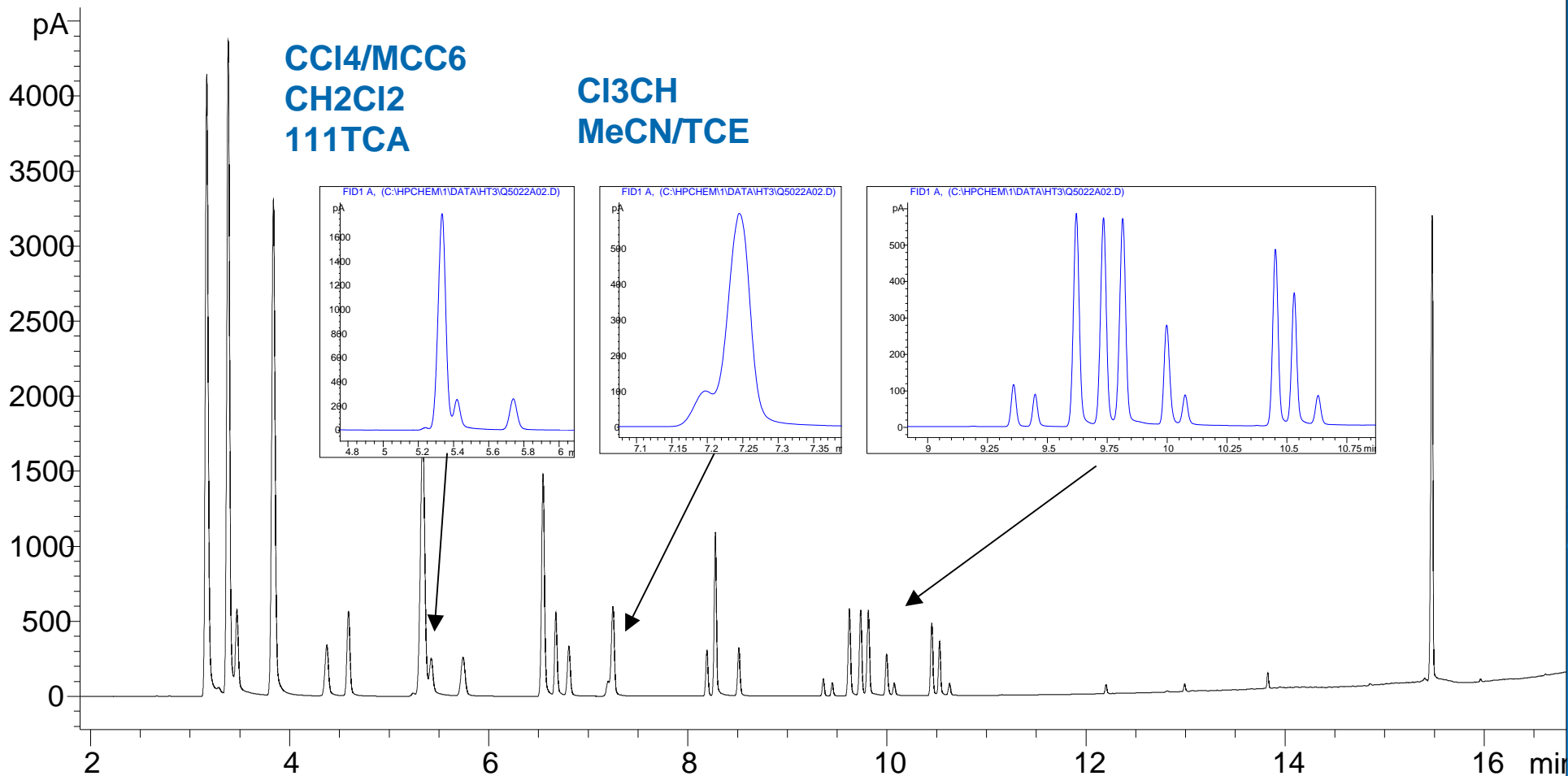


# Flow Modulation Pulses

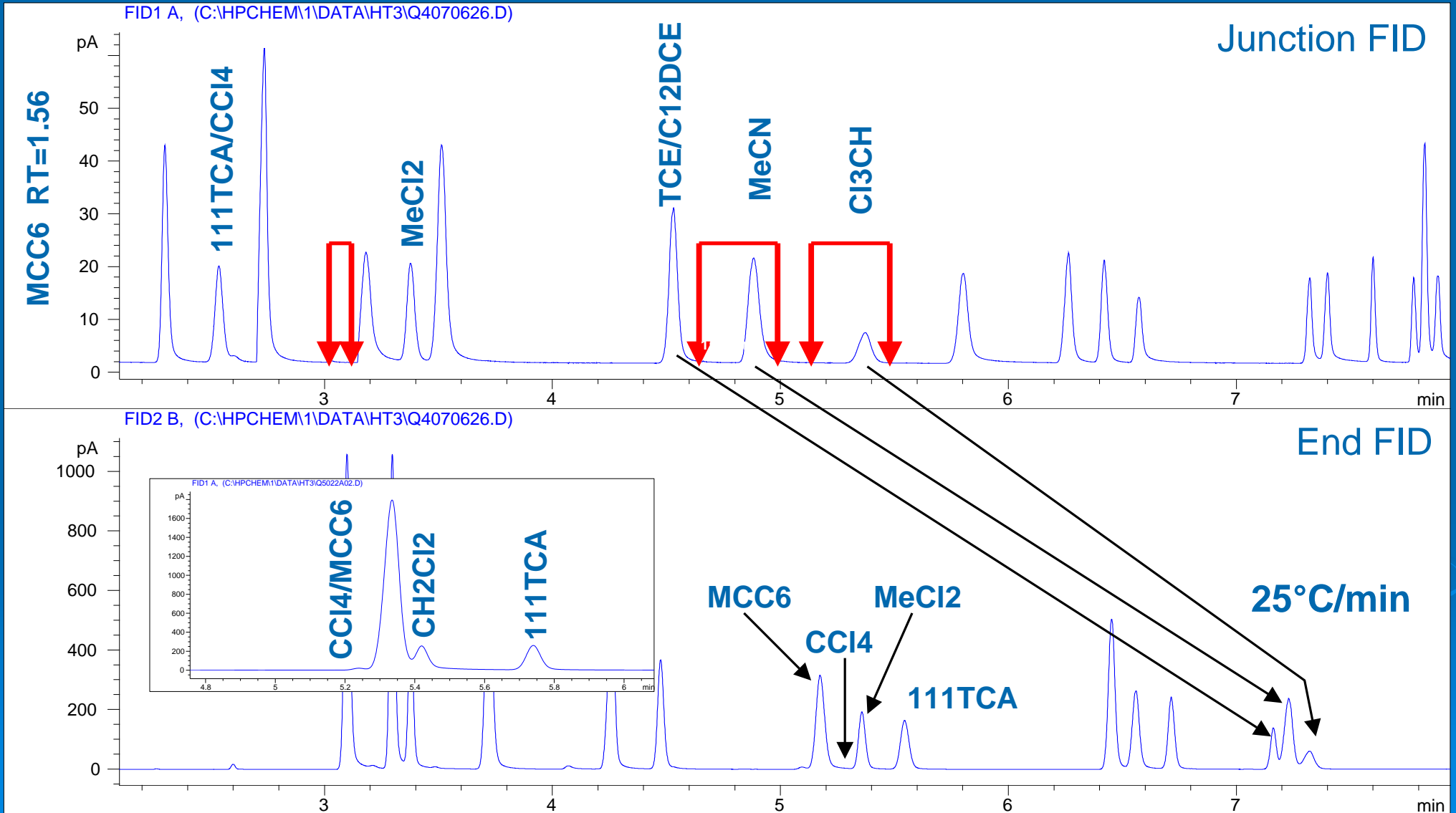


# Stabilwax 15m x 0.25mm x 0.5df Rtx-200 30m x 0.25mm x 1.0df Analysis without Pulses 2<sup>nd</sup> FID

FID1 A, (C:\HPCHEM\1\DATA\HT3\Q5022A02.D)



# Three Flow Modulation Pulses



## Teledyne Tekmar HT7000

Platen Temperature:	140°C
Sample Equilibration Time:	5 minutes
Mixing Time:	10 minutes
Mixing Power:	2
Mixture Stabilization Time:	1
Pressure Time:	0.2 minutes
Pressure Equilibrium:	0.3 minutes
Loop Fill Time:	0.1 minutes
Loop Equilibration Time:	0.05 minutes
Injection Time:	1.0 minutes
Loop/Line Temperature:	250°C
Vial Size:	22ml high temperature vials
Sample Loop Size:	Silcosteel 1ml Standard Size.
Static Vial Pressure:	3.5 PSI Helium
Vial Pressurization:	8 PSI Helium
Variable Injection Pressure (VIPR)	5 PSI Helium
Concentration:	200ppm each component.
Solvent:	1,3-dimethyl-2-imidazolidinone (DMI)
Interface:	plumbed through injection port 1:20 split



**GC** Agilent 6890  
**Injection Port Temperature:** 250°C  
**Carrier gas:** helium, constant flow  
**Flow rate:** 2.3 ml/min, 25.6psi @ 40°C.  
**Oven temperature:** 40°C (hold 2 min.) to 55°C @ 4°C/min. (no hold) to 110°C @ **25°C/min.** (hold 2 min.) to 250°C @ 25°C/min (hold 5 minutes)  
**Total Runtime:** 20.55 minutes  
Agilent Dual Flame Ionization Detectors

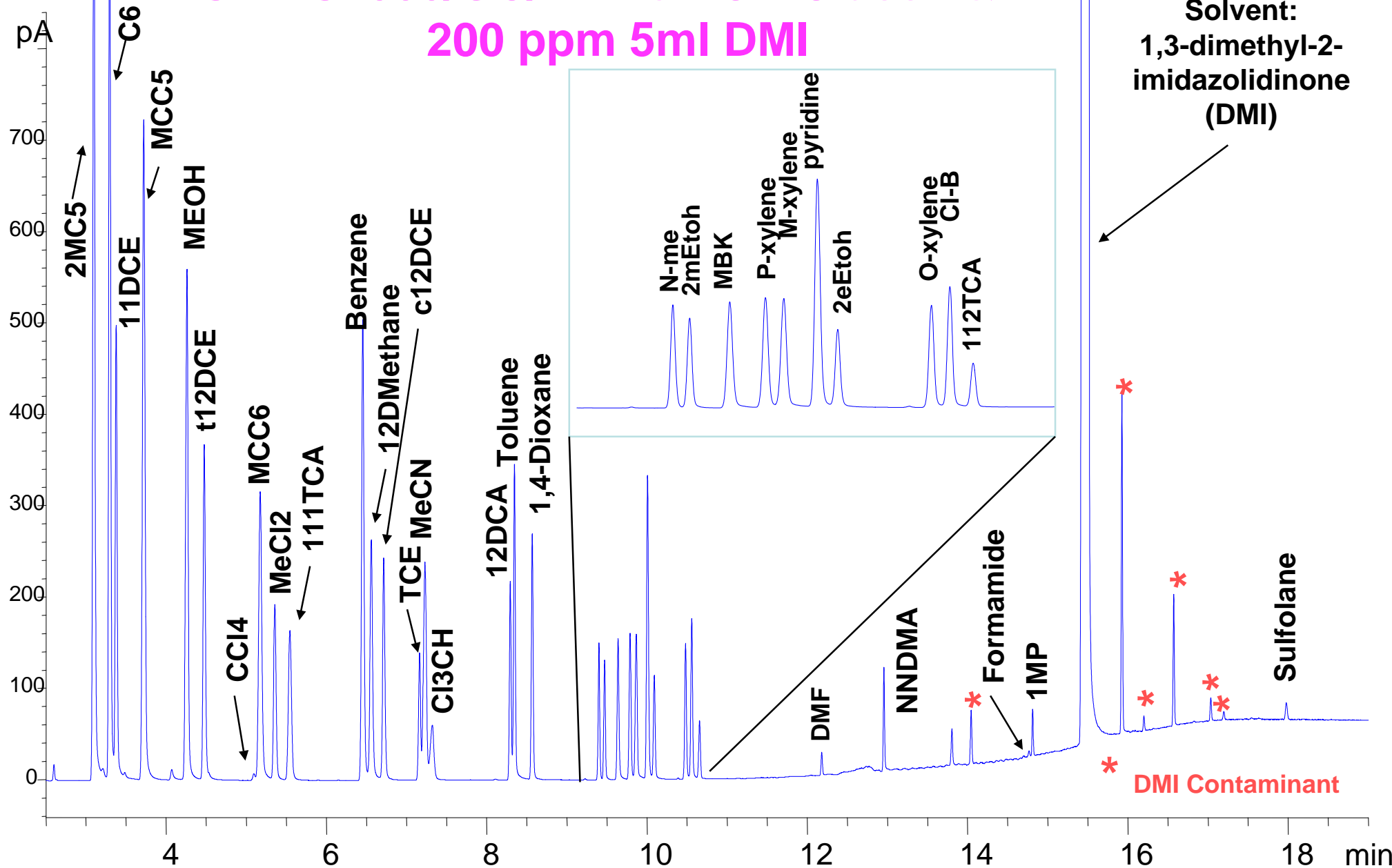
### Restek's Stop-Flow Unit Pulse Settings:

**Injection Port Connection:** cool-on-column injector.  
**Pressure:** 31.0 PSI constant pressure  
**Pulses:**

Valve Closed	0.00 minutes.
Valve Open	3.00 minutes
Valve Closed	3.15 minutes
Valve Open	4.65 minutes
Valve Closed	5.02 minutes
Valve Open	5.10 minutes
Valve Closed	5.40 minutes

# SF-HS7000/GC/FID for ICH Class I & II

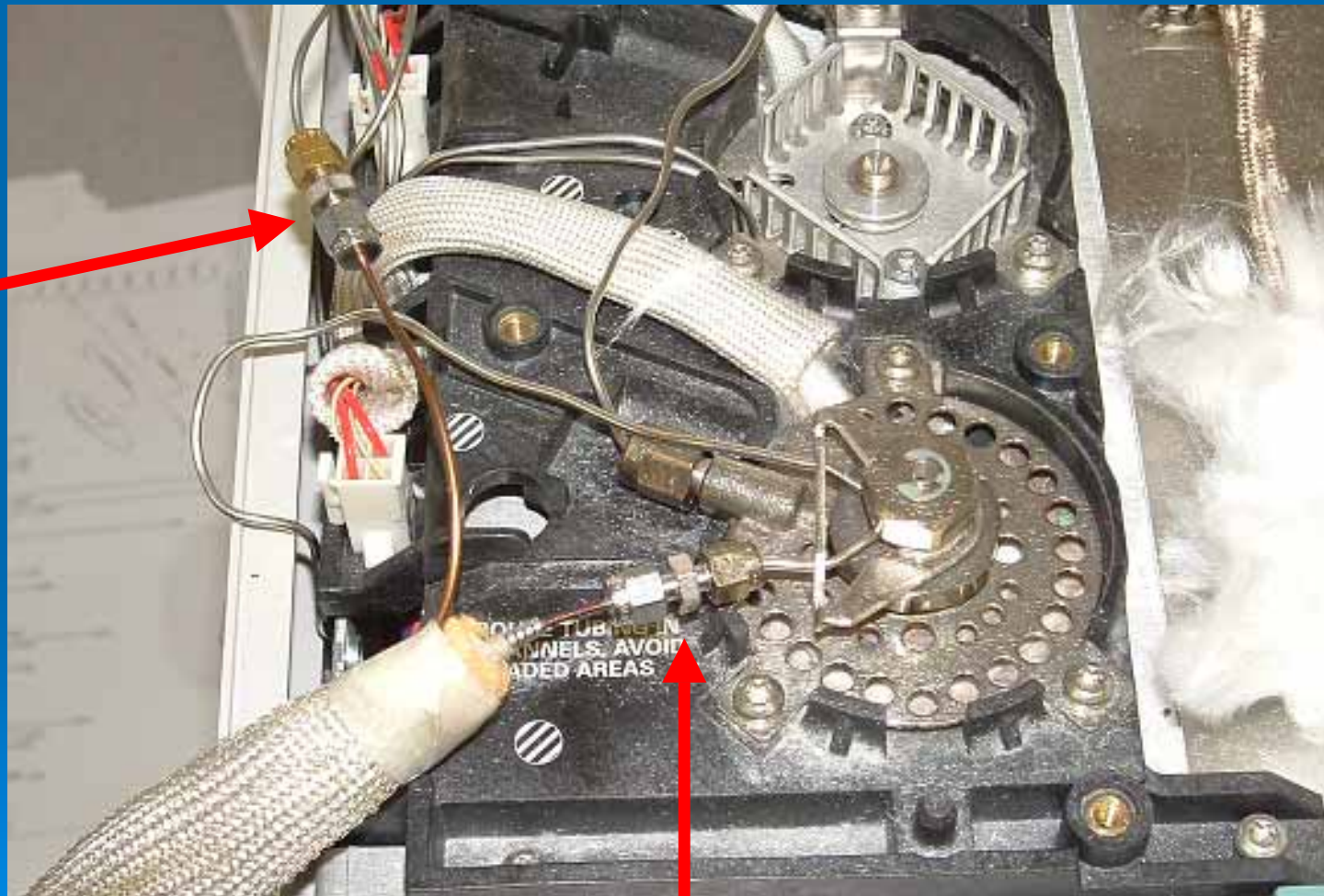
## 200 ppm 5ml DMI



# Teledyne Tekmar HT3 HS/HS-Trap



# Instrument Setup



# HT3 Conditions Using DMI

Constant Heat Time	ON
G.C. Cycle Time	23.00 min
Valve Oven Temp	150 C
Transfer Line Temp	150 C
Standby Flow Rate	50mL/min
Platen / Sample Temp	150 C
Platen Temp Equil. Time	0.10 min
Sample Equil. Time	1.00 min
Mixer	ON
Mixing Time	10.00 min
Mixing Level	Level 5
Mixer Stabilize Time	0.50 min
Pressure	8 PSIG
Pressure Time	2.00 min
Pressure Equil. Time	0.50 min
Loop Fill Pressure	5 PSIG
Loop Fill Time	2.00 min
Loop Fill Equil. Time	0.50 min
Inject Time	1.00 min

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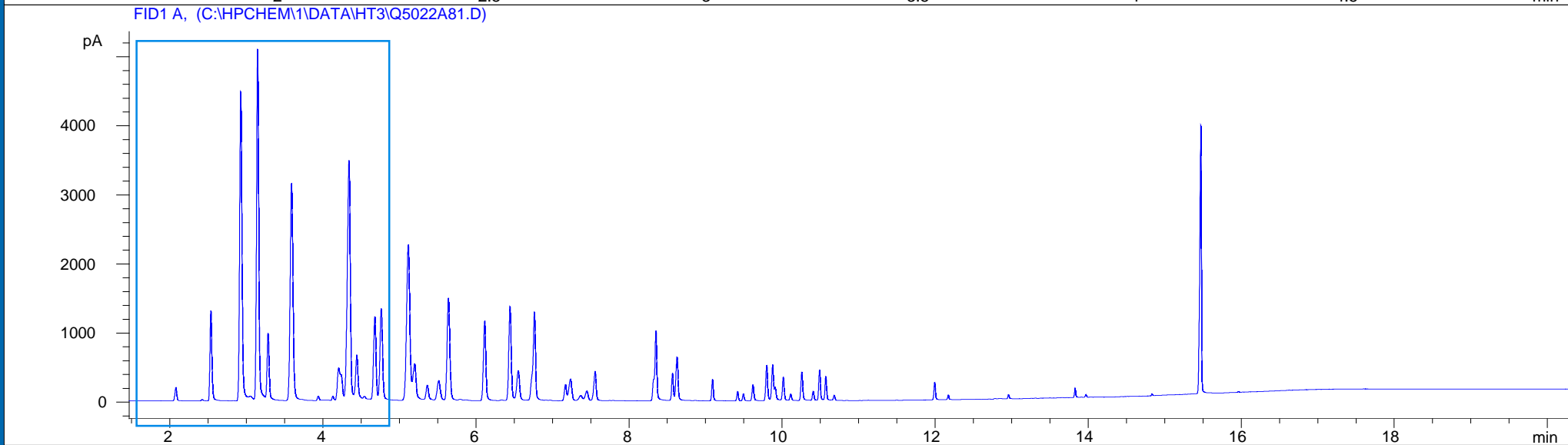
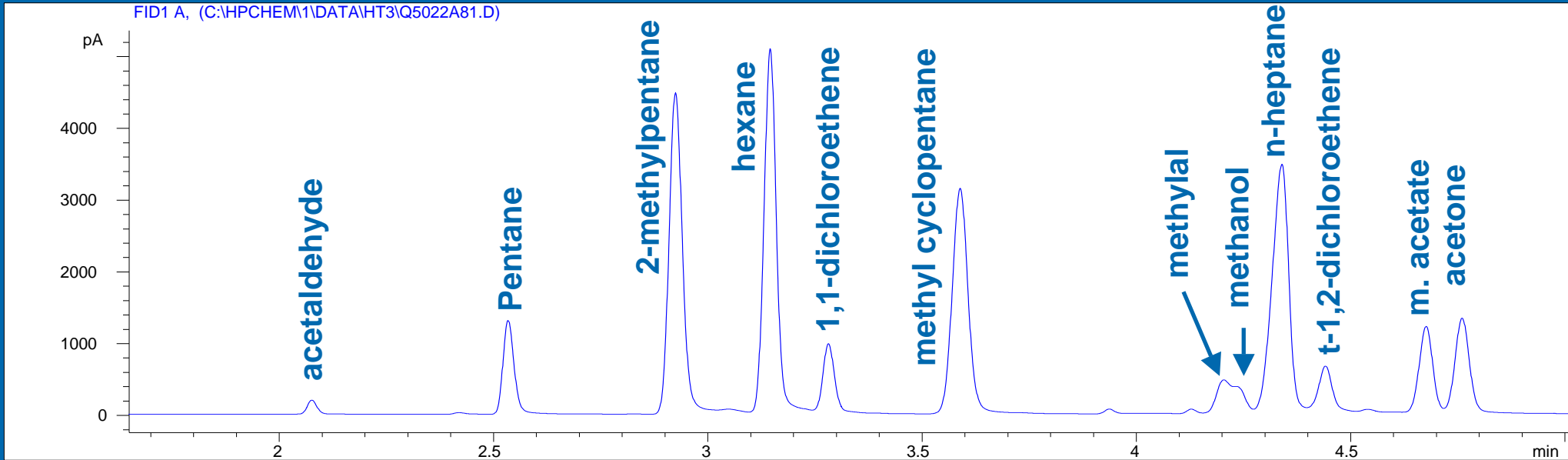


# Class III Added Residual Solvents



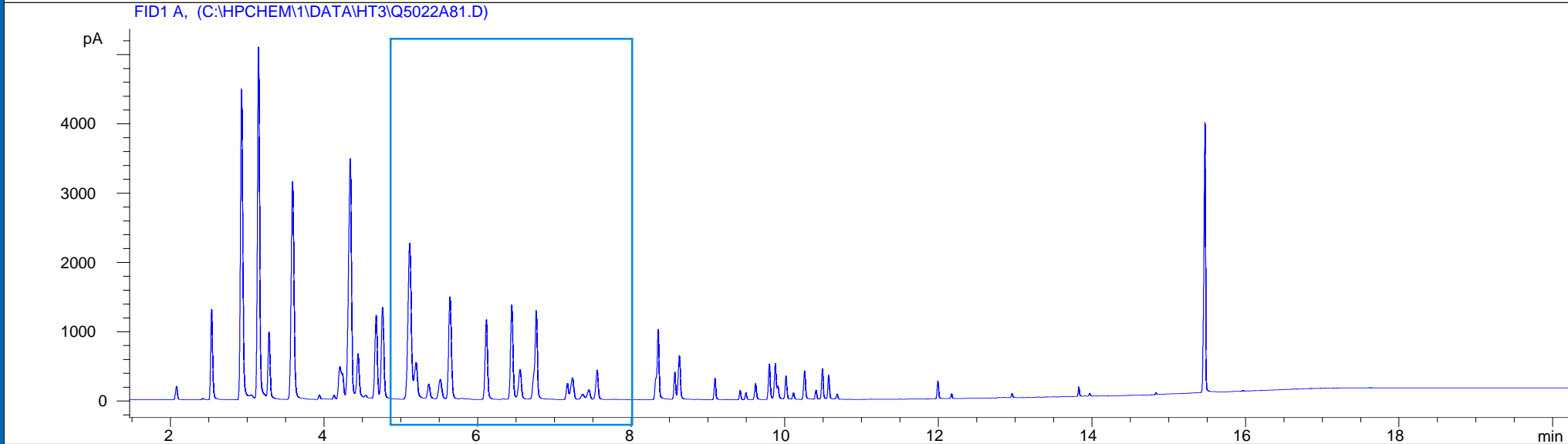
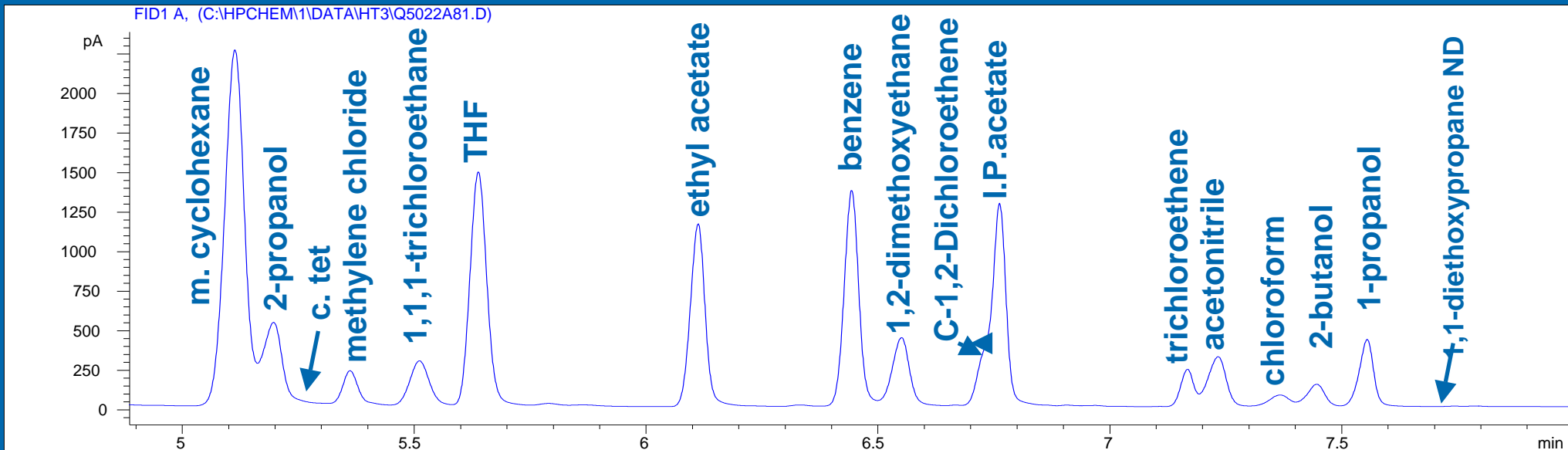
<u>compound</u>	<u>class</u>
pentane	3
methylal	4
pentane	3
n-heptane (C7)	3
methyl acetate	3
acetone	3
2-propanol	3
tetrahydrofuran	3
ethyl acetate	3
isopropyl acetate	3
2-butanol	3
1-propanol	3
1,1-diethoxypropane	4
hexanone (MIBK)	3
1-butanol	3
isoamyl alcohol	3
isoamyl acetate	S
1-pentanol	3
anisole	3
dimethyl sulfoxide	3

# Class I,II,III 2<sup>nd</sup> FID by HS

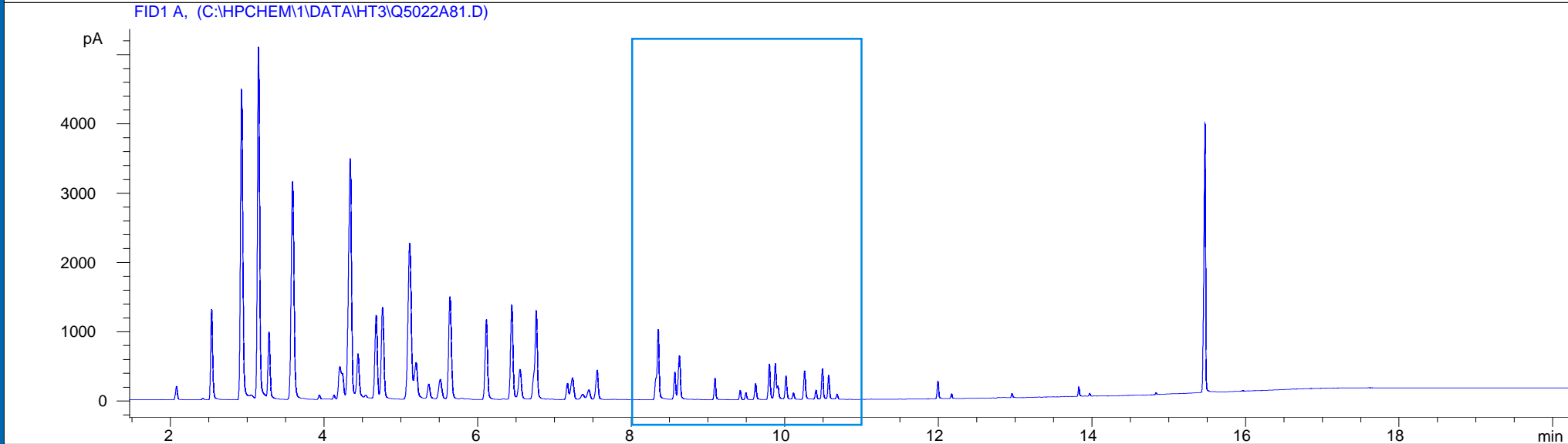
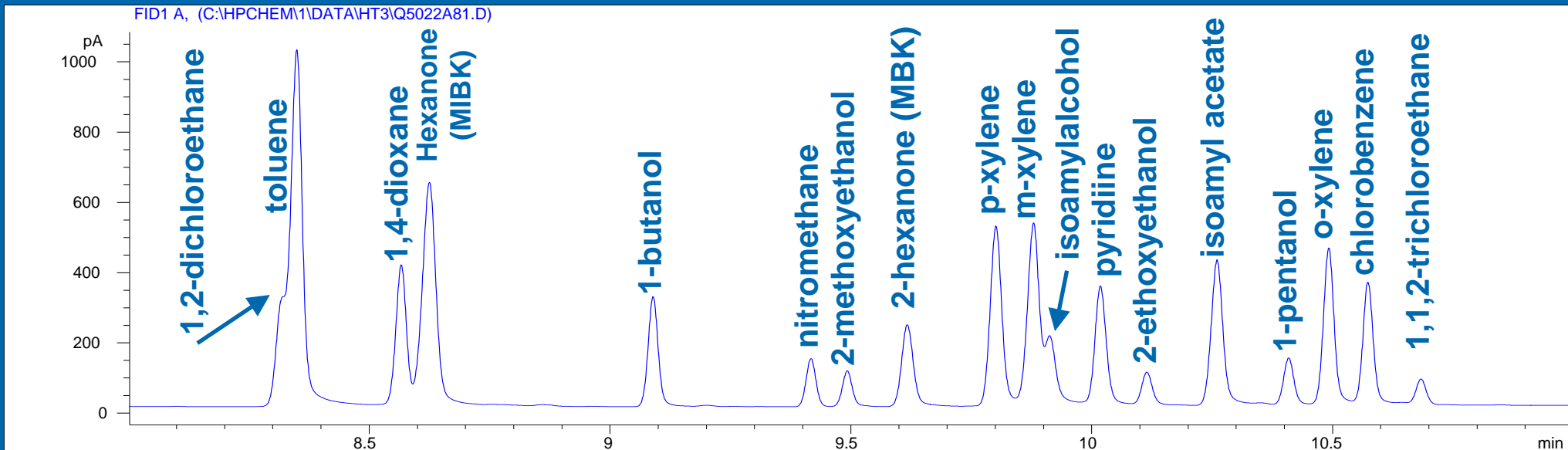




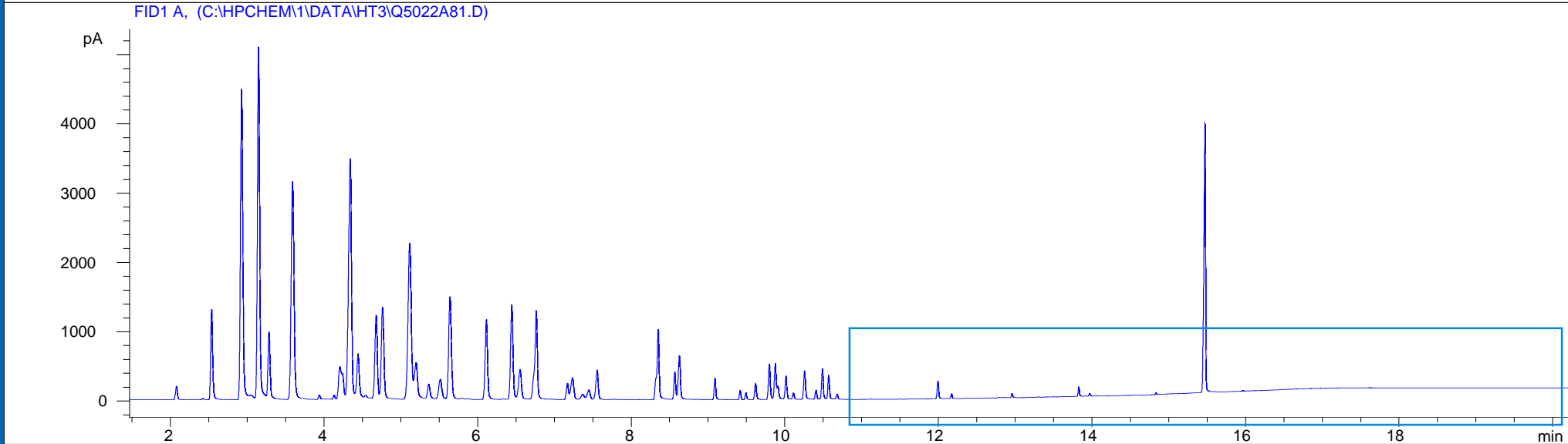
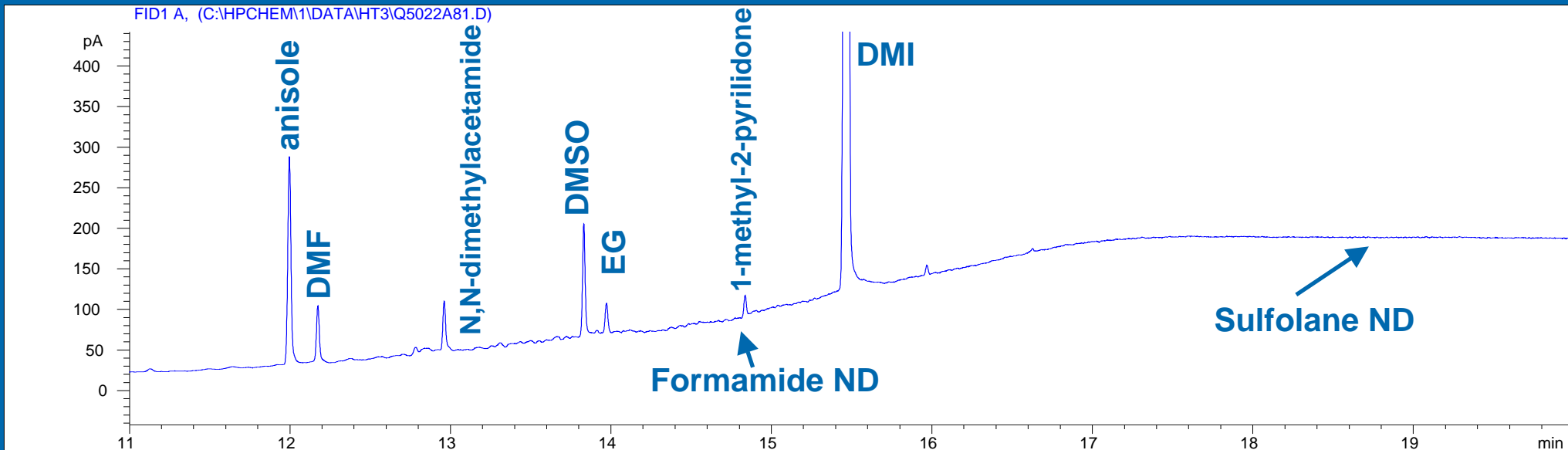
# Class I,II,III 2<sup>nd</sup> FID by HS



# Class I,II,III 2<sup>nd</sup> FID by HS



# Class I,II,III 2<sup>nd</sup> FID by HS (spiked @ 400ppm)



# Stabilwax / Rtx-200 Unresolved

## Under Current Conditions

- methylal (s) / methanol (II)
- n-heptane (III) / isooctane (s)
- t-1,2-DCE (II) / ethyl formate (III)
- ethanol (III) / methyl cyclohexane (II)
- 2-butanone (III) / 1,2-dimethoxyethane (II)
- isobutyl acetate (III) / hexanone (III)
- 1-pentanol (III) / isopropylbenzene (III)
- c-1,2-dichloroethene (II) / isopropyl acetate (III)

# Summary of Stop-Flow GC

- Ability to “Tune” the Selectivity
- Flexibility
  - Standard dimension columns
  - Can vary the pulse sequences
- Significant Improvements in Analysis Times Possible
  - Fast oven programs, high flow rates

# Conclusions

- Continue evaluation of current phases
- Continue work on a new stationary phases
  - Using computer modeling
  - Goal: resolve Class I, II, III, other solvents.
- Continue with Stop-Flow technology

Special Thanks to Ed Price, Eric Heggs, Brian Wallace & Terry Jeffers of Teledyne Tekmar for their assistance in setup and operation of the HT3 Headspace unit.

